

L Number	Hits	Search Text	DB	Time stamp
1	1	((("5847460") or ("5847460"))).PN.	USPAT; US-PGPUB	2003/11/05 17:48
2	2	((("5877076") or ("5847460"))).PN.	USPAT; US-PGPUB	2003/11/05 17:53
3	774	(contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:27
4	208	((contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))) same photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:15
5	115	((((contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))) same photoresist ) and @pd<20001103	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:15
6	31	(((((contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))) same photoresist ) and @pd<20001103) and (second near etch\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:16
9	291	((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:34
10	16	((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3)) same (trench or contact near open\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:35

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-	1	((("5847460") or ("5847460")).PN.	USPAT; US-PGPUB	2003/11/05 17:48
-	2	((("5877076") or ("5847460")).PN.	USPAT; US-PGPUB	2003/11/05 17:53
-	774	(contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:27
-	208	((contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))) same photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:15
-	115	((contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))) same photoresist ) and @pd<20001103	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:15
-	31	((contact near open\$3) same (etch\$3 same (cap or encapsulat\$3 or protect\$3))) same photoresist ) and @pd<20001103) and (second near etch\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:16
-	291	((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:34
-	16	((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3)) same (trench or contact near open\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 18:35
-	0	(dual near damascene) same (((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 19:26
-	5	(dual near damascene) and (((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 19:31
-	54	(dielectric or nitride) same (((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 19:32
-	15	((dielectric or nitride) same (((partial near etch\$3) or (half near etch\$3)) same (cap or encapsulat\$3 or protect\$3))) and @pd<20001103	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/05 19:32